

Chip Quik® Introduces a New Low Temperature Solder Paste

After numerous requests for a safe low temperature solder to be used on heat sensitive components and assemblies, Chip Quik® now has the solution



“Reduce Heat - Reduce Damage”

This Solder Paste is Liquidus at 138°C, 281°F

Now Prevent Thermal Damage by Lowering the Temperature Setting on Any of These Heating Devices

- Solder Iron
- Hot air Blower
- Reflow Oven
- Bottom Preheater

Chip Quik® Pt. # **SMDLTFP** Low Temp Solder Paste

Sn42/Bi58 Melting Point 138°C 281°F (Eutectic)

5cc syringe w/ tip 15grams

87% Metal Particle Size 25-45 Microns

Chip Quik®, Inc.

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